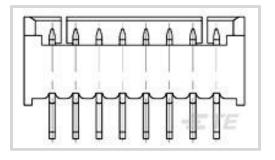
# 1734598-4 - ACTIVE

TE Internal #: 1734598-4 PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.25 mm [. 049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural

### View on TE.com >



Connectors > PCB Connectors > PCB Headers & Receptacles > AMP HPI 1.25 mm Headers



## Connector System: Wire-to-Board

Number of Positions: **4** 

Number of Rows: 1

Centerline (Pitch): 1.25 mm [.049 in ]

PCB Mount Orientation: Vertical

All AMP HPI 1.25 mm Headers (100)

## Features

## Product Type Features

Connector System	Wire-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
PCB Connector Assembly Type	PCB Mount Header
Configuration Features	
Connector Contact Load Condition	Fully Loaded
Number of Positions	4
Number of Rows	1
PCB Mount Orientation	Vertical
Electrical Characteristics	
Operating Voltage	100 VAC
Body Features	
Primary Product Color	Natural
Contact Features	
PCB Contact Termination Area Plating Material Thickness	3.08 μm[120 μin]
Contact Layout	Inline

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Mating Tab Width	.76 mm[.03 in]
Mating Tab Thickness	.3 mm[.012 in]
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Finish	Matte
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Tin
Contact Type	Pin
Contact Current Rating (Max)	.8 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.3 mm[.012 in]
Rectangular Termination Post & Tail Width	.35 mm[.014 in]
Termination Post & Tail Length	1.7 mm[.067 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment Type	Polarization
Mating Retention	Without
Connector Mounting Type	Board Mount
Mating Alignment	With
PCB Mount Alignment	Without
PCB Mount Retention	Without
Housing Features	
Housing Material	PA 9T GF
Centerline (Pitch)	1.25 mm[.049 in]
Dimensions	
Connector Length	6.75 mm[.266 in]
Connector Height	4.7 mm[.185 in]
Connector Width	3.2 mm[.126 in]
Usage Conditions	
Operating Temperature Range	-25 – 85 °C[-13 – 185 °F]
Operation/Application	
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Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	90
Packaging Type	Box, Tube
Product Compliance For compliance documentation, visit the product page on TE.com> EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-onreach

## **Compatible Parts**

PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



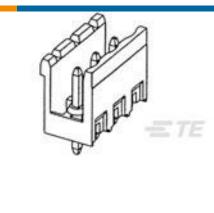


# Customers Also Bought





TE Part #20009605-19



TE Part #282825-2

Compact Compression Load Cell

TERMI-BLOK HEADER, ASSY90 2P.5,

## Documents

Product Drawings 1.25 WTB HDR DIP, 4 POS

English

**CAD** Files

3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_1734598-4\_R.2d\_dxf.zip

English

Customer View Model

ENG\_CVM\_CVM\_1734598-4\_R.3d\_igs.zip

English

Customer View Model

ENG\_CVM\_CVM\_1734598-4\_R.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use

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PCB Mount Header, Vertical, Wire-to-Board, 4 Position, 1.25 mm [.049 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, Signal, Natural



Datasheets & Catalog Pages

HPI Connectors QRG

English

**Product Specifications** 

Application Specification

English

Product Environmental Compliance MD\_1734598-4\_08212012829

English

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English